KY DDLM31.23

SYNIOS® S2222

This square package with just 2mm outline combines best performance with a small footprint. A centralized chip allows an easy integration in optical systems. The availability of different main colors and white points gives highest flexibility in various application areas.



Applications

- Architecture
- Architecture / Garden Lighting (LED & Laser)
- Electronic Equipment
- Industrial Automation (Machine Controls, Light Barriers, Vision Controls)
- Mood Lighting
- Smart Home, Metering
- Transportation, Plane, Ship
- White Goods

Features:

- Package: white SMT package, colorless clear silicone resin
- Chip technology: Thinfilm
- Typ. Radiation: 120° (Lambertian emitter)
- Color: λ_{dom} = 590 nm (• yellow)
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)





Ordering Information

| Туре | Luminous Flux ¹⁾ I _F = 140 mA Φ_V | Ordering Code |
|---------------------------|--|---------------|
| KY DDLM31.23-8F5H-36-C4U4 | 15.9 31.5 lm | Q65112A5715 |



Maximum Ratings

| Parameter | Symbol | | Values |
|--|------------------|------|--------|
| Operating Temperature | T _{op} | min. | -40 °C |
| | | max. | 110 °C |
| Storage Temperature | T _{stg} | min. | -40 °C |
| | 3 | max. | 110 °C |
| Junction Temperature | Tj | max. | 125 °C |
| Junction Temperature for short time applications* | T _i | max. | 150 °C |
| Forward current | I _F | min. | 10 mA |
| T _s = 25 °C | | max. | 200 mA |
| Surge Current t ≤ 10 μs; D = 0.005 ; T _s = 25 °C | Ι _{FS} | max. | 400 mA |
| Reverse voltage ²⁾ T _s = 25 °C | V _R | max. | 12 V |
| ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2) | V_{ESD} | | 2 kV |

* The median lifetime (L70/B50) for Tj = 150° C is 100h.



Characteristics

 $I_{_{
m F}}$ = 140 mA; $T_{_{
m S}}$ = 25 °C

| Parameter | Symbol | | Values |
|--|------------------|----------------------|----------------------------|
| Dominant Wavelength ³⁾ I _F = 140 mA | λ_{dom} | min. typ. max. | 583 nm 590 nm 595 nm |
| Viewing angle at 50% ${\rm I_v}$ | 2φ | typ. | 120 ° |
| Forward Voltage ⁴⁾ I _F = 140 mA | V _F | min. typ. max. | 1.70 V 2.25 V 2.70 V |
| Reverse current ²⁾ V _R = 12 V | Ι _R | typ. max. | 0.01 μA 10 μA |
| Real thermal resistance junction/solderpoint 5) | $R_{thJS real}$ | typ. max. | 25 K / W 30 K / W |
| Electrical thermal resistance junction/solderpoint $^{\rm 5)}$ with efficiency $\eta_{\rm e}$ = 15 % | $R_{thJS elec.}$ | typ. max. | 21 K / W 26 K / W |

Brightness Groups

| Group | Luminous Flux ¹⁾ I _F = 140 mA min. Φ _v | Luminous Flux ¹⁾ I _F = 140 mA max. Φ _V | Luminous Intensity ⁶⁾ I _F = 140 mA typ. I _v | |
|-------|--|--|---|--|
| 8F | 15.9 lm | 18.0 lm | 5.6 cd | |
| 5G | 18.0 lm | 20.1 lm | 6.3 cd | |
| 6G | 20.1 lm | 22.4 lm | 7.0 cd | |
| 7G | 22.4 lm | 25.0 lm | 7.8 cd | |
| 8G | 25.0 lm | 28.0 lm | 8.7 cd | |
| 5H | 28.0 lm | 31.5 lm | 9.8 cd | |

Forward Voltage Groups

| Group | Forward Voltage ⁴⁾ I _F = 140 mA min. V _F | Forward Voltage ⁴⁾ I _F = 140 mA max. V _F | |
|-------|--|--|--|
| C4 | 1.70 V | 1.90 V | |
| G4 | 1.90 V | 2.10 V | |
| L4 | 2.10 V | 2.30 V | |
| Q4 | 2.30 V | 2.50 V | |
| U4 | 2.50 V | 2.70 V | |

Wavelength Groups

| Group | Dominant Wavelength ³⁾ $I_F = 140 \text{ mA}$ min. λ_{dom} | Dominant Wavelength ³⁾ I _F = 140 mA max. λ _{dom} |
|-------|--|--|
| 3 | 583 nm | 586 nm |
| 4 | 586 nm | 589 nm |
| 5 | 589 nm | 592 nm |
| 6 | 592 nm | 595 nm |



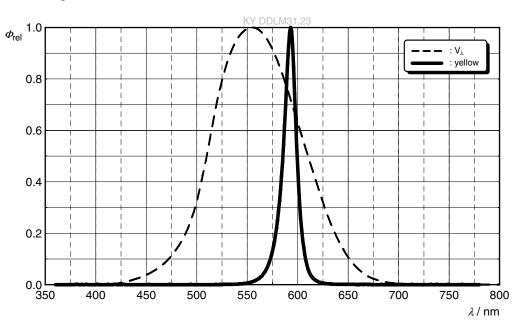
Group Name on Label

| Example: 5G-3-C4 Brightness | Wavelength | Forward Voltage |
|--------------------------------|------------|-----------------|
| 5G | 3 | C4 |



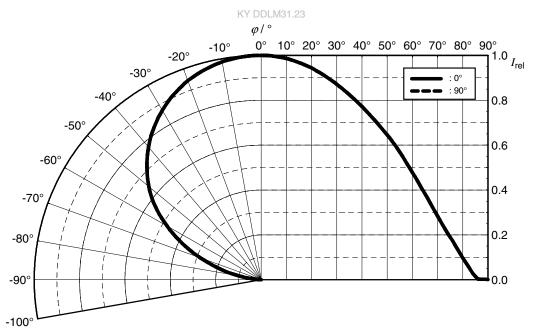
Relative Spectral Emission⁶⁾

 $\Phi_{_{rel}}$ = f (λ); I $_{_F}$ = 140 mA; T $_{_S}$ = 25 °C



Radiation Characteristics⁶⁾

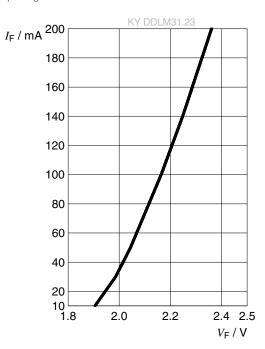
 $I_{rel} = f(\phi); T_s = 25 \ ^{\circ}C$





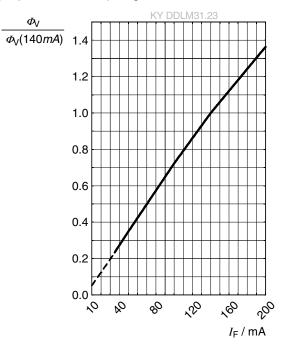
Forward current ⁶⁾

 $I_{_{\rm F}} = f(V_{_{\rm F}}); T_{_{\rm S}} = 25 \ ^{\circ}{\rm C}$



Relative Luminous Flux ^{6), 7)}

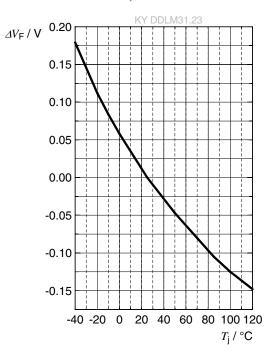
 $\Phi_{v}/\Phi_{v}(140 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$





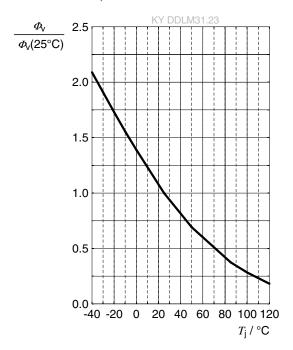
Forward Voltage ⁶⁾

 $\Delta V_{_F} = V_{_F} - V_{_F}(25 \text{ °C}) = f(T_{_j}); I_{_F} = 140 \text{ mA}$



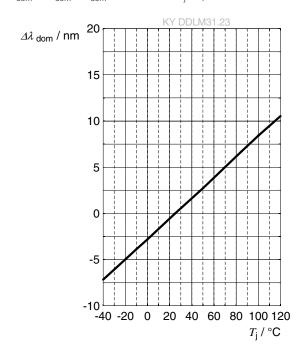
Relative Luminous Flux⁶⁾

 $\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{j}); I_{F} = 140 \text{ mA}$



Dominant Wavelength⁶⁾

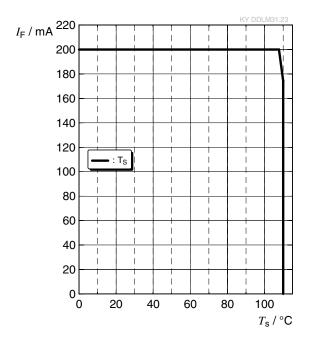
 $\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom} (25 \text{ °C}) = f(T_j); I_F = 140 \text{ mA}$





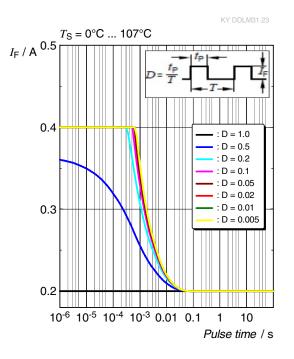
Max. Permissible Forward Current

 $I_{F} = f(T)$



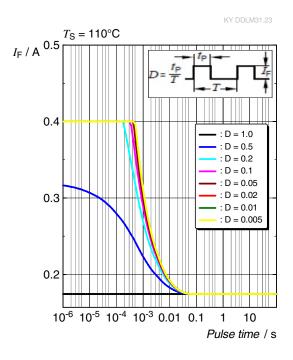
Permissible Pulse Handling Capability

 $I_{_{P}} = f(t_{_{P}}); D: Duty cycle$



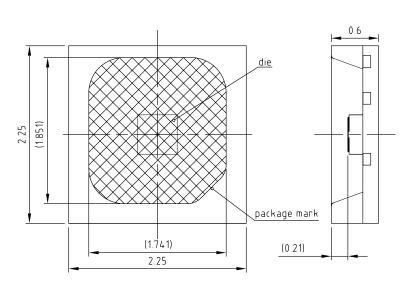
Permissible Pulse Handling Capability

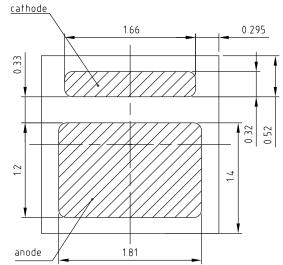
 $I_{_{P}} = f(t_{_{p}}); D: Duty cycle$





Dimensional Drawing ⁸⁾





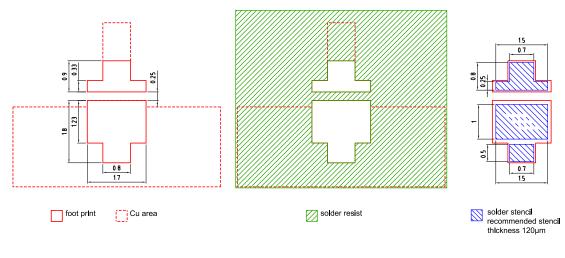
general tolerance ±0.1 lead finish Ag C67062-A0259-A5-05

Further Information:

| Approximate Weight: | 6.0 mg |
|---------------------|--------|
| Package marking: | Anode |

Electrical Internal Circuit

Recommended Solder Pad⁸⁾



board material selection has high impact on system reliability

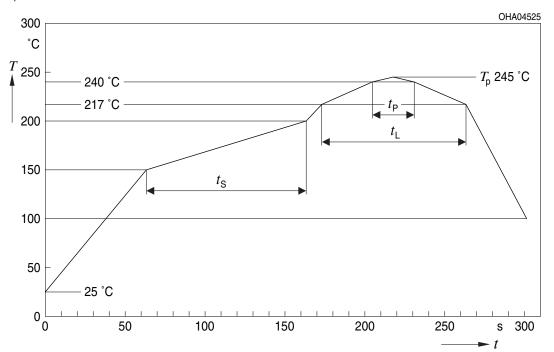
E062.3010.249 -01

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.



Reflow Soldering Profile

Product complies to MSL Level 3 acc. to JEDEC J-STD-020E



| Profile Feature | Symbol | Pb-Free (SnAgCu) Assembly | | | Unit |
|--|----------------|---------------------------|----------------|---------|------|
| | | Minimum | Recommendation | Maximum | |
| Ramp-up rate to preheat ^{*)} 25 °C to 150 °C | | | 2 | 3 | K/s |
| Time t _s T _{smin} to T _{smax} | t _s | 60 | 100 | 120 | S |
| Ramp-up rate to peak ^{*)} T_{smax} to T_{p} | | | 2 | 3 | K/s |
| Liquidus temperature | TL | | 217 | | °C |
| Time above liquidus temperature | t | | 80 | 100 | S |
| Peak temperature | Τ _Ρ | | 245 | 260 | °C |
| Time within 5 °C of the specified peak temperature T_p - 5 K | t _P | 10 | 20 | 30 | S |
| Ramp-down rate* T _P to 100 °C | | | 3 | 6 | K/s |
| Time 25 °C to T _P | | | | 480 | S |

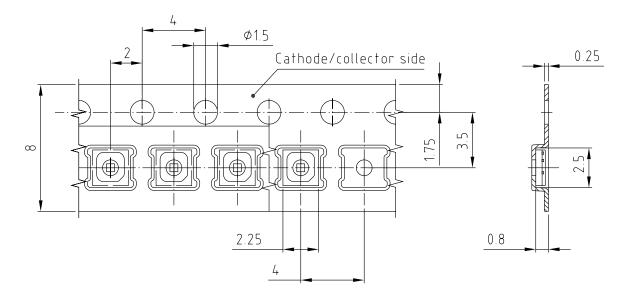
All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



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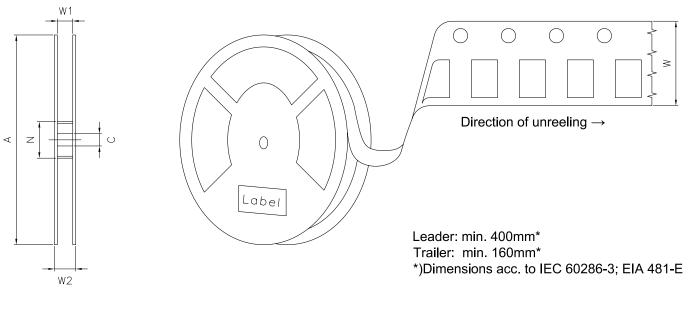
Taping⁸⁾



C67062-A0259-B13-07



Tape and Reel ⁹⁾

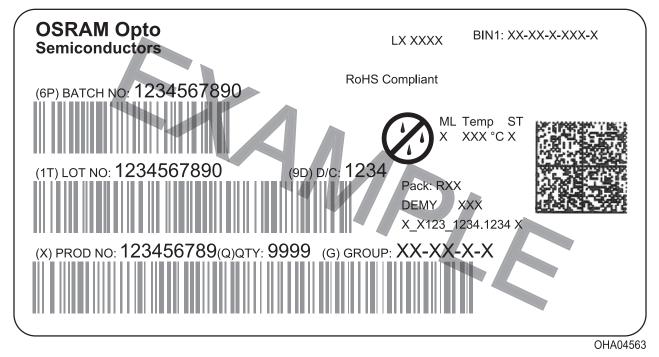


Reel Dimensions

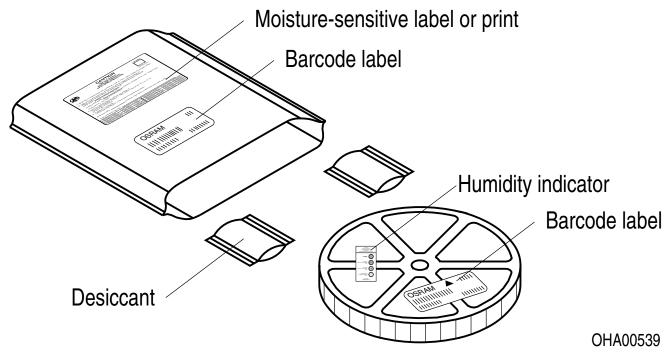
| А | W | N _{min} | W ₁ | $W_{2 \max}$ | Pieces per PU |
|--------|--------------------|------------------|----------------|--------------|---------------|
| 180 mm | 8 + 0.3 / - 0.1 mm | 60 mm | 8.4 + 2 mm | 14.4 mm | 4000 |



Barcode-Product-Label (BPL)



Dry Packing Process and Materials⁸⁾



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



Glossary

- ¹⁾ **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 8 % and an expanded uncertainty of ± 11 % (acc. to GUM with a coverage factor of k = 3).
- ²⁾ **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- ³⁾ **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- ⁴⁾ **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of k = 3).
- ⁵⁾ **Thermal Resistance:** Rth max is based on statistic values (6σ).
- ⁶⁾ **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁷⁾ **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- ⁸⁾ **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ⁹⁾ **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



| Revisior | Revision History | | | |
|----------|------------------|--|--|--|
| Version | Date | Change | | |
| 1.0 | 2019-12-15 | Initial Version | | |
| 1.1 | 2020-01-13 | Brand | | |
| 1.2 | 2020-04-24 | Schematic Transportation Box Dimensions of Transportation Box | | |
| 1.3 | 2020-07-17 | Product Image | | |



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